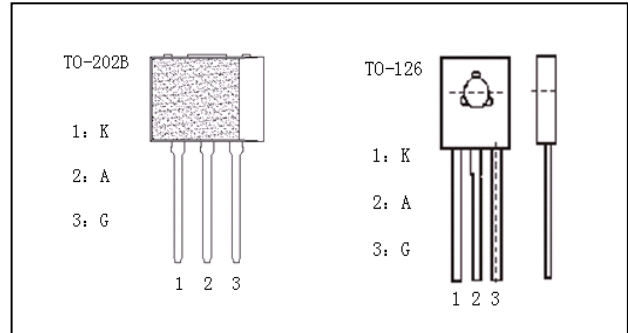


Silicon Controlled Rectifiers—TSE 0405

Applications

Designed primarily application for motorcycle ignition ,it's also widely used for switching control circuit, small motor controller, lamp controller, leakage current detection, logic circuit driver, lamps and lanterns relay stimulus, larger power SCR driver, and others.



Features

- Low forward voltage drop
- High peak repetitive off-state voltage
- High sensitivity of triggering
- High reliability
- Package: TO-126 TO-202B

Absolute rating (Ta=25°C)

| Parameter | Symbol | Ratings | Unit |
|--|--------------|---------|------|
| Peak Repetitive Off-State Voltage | V_{DRM} | 600 | V |
| Peak Repetitive Reverse Voltage | V_{RRM} | 600 | V |
| On-State Average Current | $I_{T(AV)}$ | 5 | A |
| RMS On-State Current | $I_{T(RMS)}$ | 8 | A |
| Non-repetitive Peak on-state Surge Current | I_{TSM} | 50 | A |
| Junction temperature | T_J | 125 | °C |
| Storage temperature | T_{stg} | -40~125 | °C |

Electrical characteristic (Ta=25°C)

| Parameter | Symbol | Unit | Criterion | | | Test conditions |
|-----------------------------------|-----------|------|-----------|-----|-----|-----------------|
| | | | Min | Typ | Max | |
| Peak Repetitive Off-State Voltage | V_{DRM} | V | 450 | 600 | | $I_T=0.1mA$ |

| | | | | | | |
|--|-----------|-----------|-----|-----|-----|--|
| Peak Repetitive Reverse Voltage | V_{RRM} | V | 450 | 600 | | $I_R=0.1mA$ |
| Peak Repetitive Off-State current | I_{DRM} | μA | | | 10 | $V_{DRM}=600V$ |
| Peak On-State Voltage | V_{TM} | V | | 1.3 | 1.7 | $I_T=8A$ |
| Holding current | I_H | mA | | 0.3 | 6 | $V_D=12V, I_{GT}=0.1A$ |
| Latching current | I_L | mA | | 0.4 | 10 | $V_D=12V, I_{GT}=0.1A$ |
| Gate trigger current ※ | I_{GT} | μA | 10 | 30 | 100 | $V_D=6V, R_L=100\Omega$ |
| Gate trigger voltage | V_{GT} | V | | | 1.2 | $V_D=6V, R_L=100\Omega$ |
| Peak gate current | I_{GM} | A | | | 1 | |
| Peak gate voltage | V_{GM} | V | | | 5 | |
| Peak reverse gate voltage | V_{RGM} | V | | | 5 | |
| Critical Rate of Rise of Off-State Voltage | dV_D/dt | $V/\mu s$ | 50 | 100 | | $V_{DM}=67\%V_{DRM}, T_j=125^\circ C, R_L=100\Omega$ |
| Critical Rate of Rise of On-State Current | dI_T/dt | $A/\mu s$ | | | 50 | $I_T=10A, I_{GT}=50mA, dI_{GT}=50mA/\mu s$ |
| Gate Non-Trigger Current | V_{GD} | V | 0.2 | | | $V_{DRM}=400V, R_{GR}=1K\Omega, T_i=125^\circ C$ |

※: The parameter is related to the operating ambient temperature

Thermal performance

| Parameter | Symbol | Condition | Value | Unit |
|--|---------|--------------|-------|--------------|
| Thermal resistance junction to mounting base | Rthj-mb | Normal state | 2.0 | $^\circ C/W$ |
| Thermal resistance junction to ambient | Rthj-a | | 90 | $^\circ C/W$ |

Characteristic curve

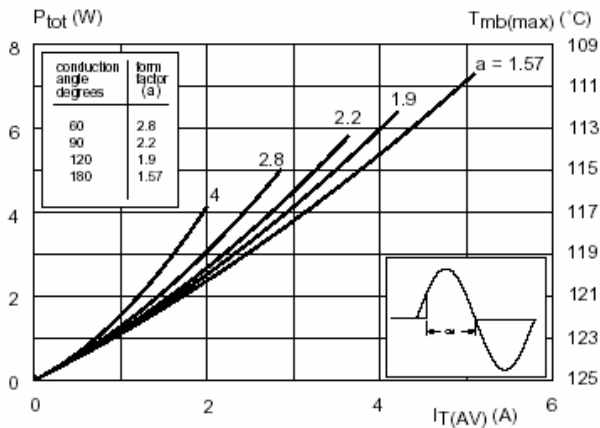


Figure1: on-state dissipation VS I_T

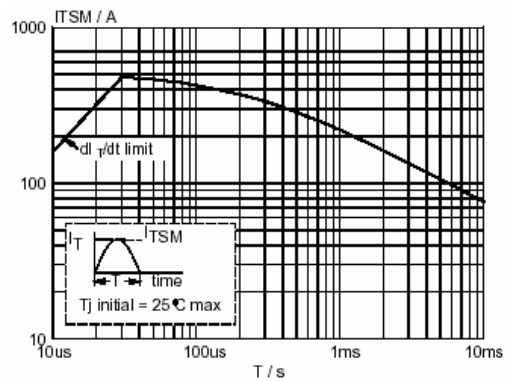


Figure2: I_{TSM} VS pulse width

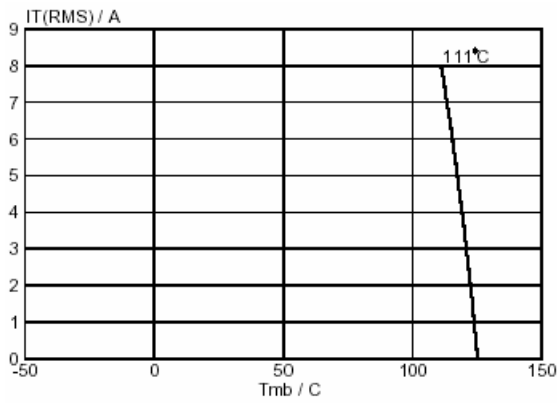


Figure3: I_T VS temperature

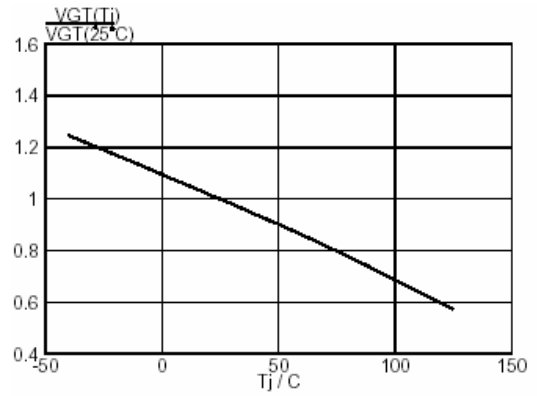


Figure4: V_{GT} VS junction temperature

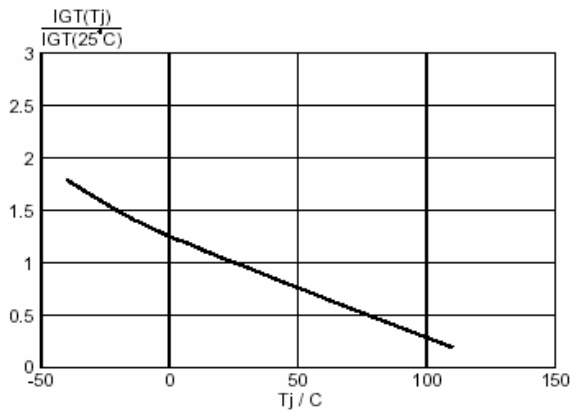


Figure5: I_{GT} VS T_j

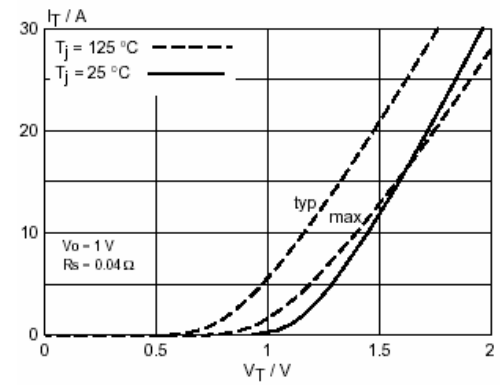


Figure6: I_T VS V_{TM}

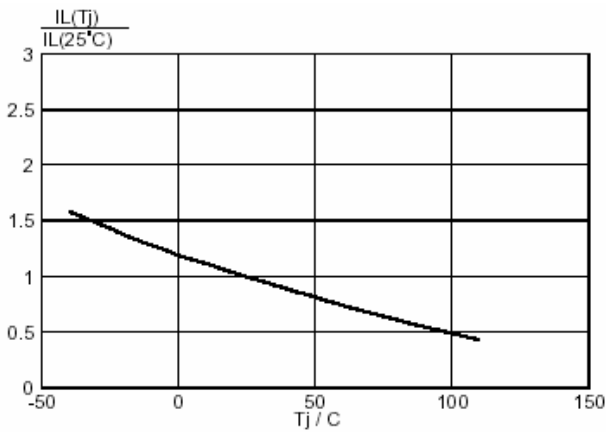


Figure7: I_L VS T_j

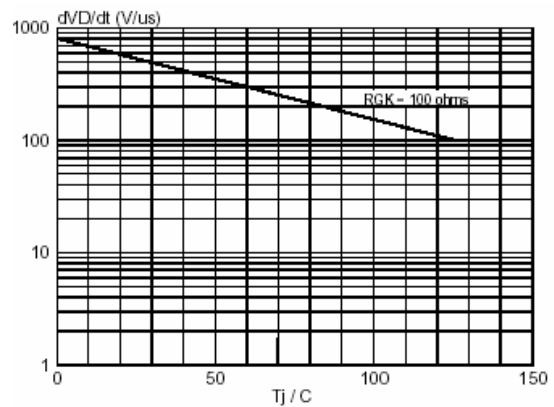


Figure8: dV_D/dt VS T_j

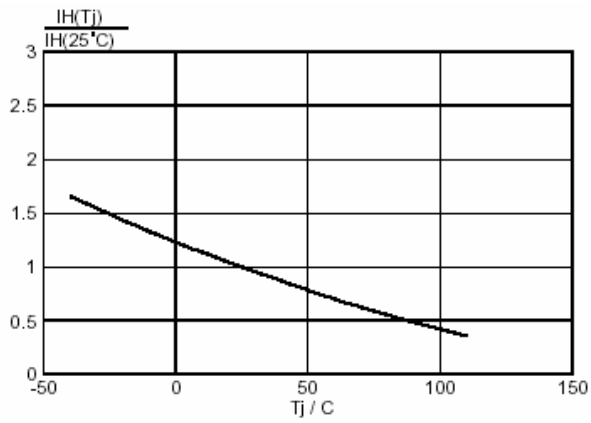


Figure9: I_H VS T_j

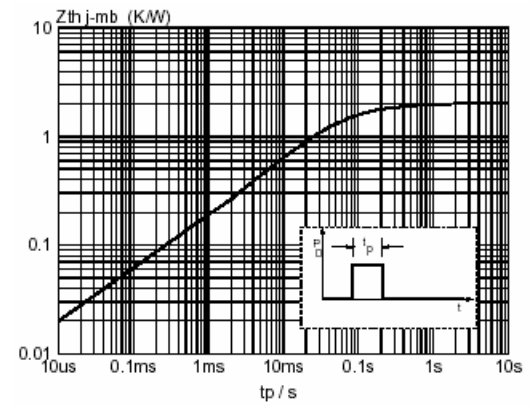


Figure10: Thermal impedance Vs pulse width